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3729  
PATENT

Docket No. 1948-4631

**THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s) : NICOLAI et al. Group Art Unit: 3729  
Serial No. : 09/423,075 Examiner: S. Smith  
Filed : November 1, 1999  
For : SHIELDING AN ELECTRONIC CARD WITH PRINTED CIRCUIT  
MOUNTED ON A METAL SUBSTRATE

**CERTIFICATE OF MAILING (37 C.F.R. 1.8a)**

Commissioner for Patents  
Washington, D.C. 20231

Sir:

I hereby certify that the following attached papers

1. Amendment; and
2. Return postcard.

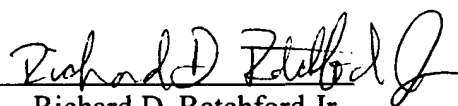
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(along with any papers referred to as being attached or enclosed) and this Certificate of Mailing are being deposited with the United States Postal Service on the date shown below with sufficient postage as first-class mail in an envelope addressed to the: Commissioner for Patents, Washington, D.C. 20231.

Respectfully submitted,

MORGAN & FINNEGAN

Date: January 24, 2002

By :   
Richard D. Ratchford Jr.

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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s): NICOLAI et al.

Group Art Unit: 3729

Serial No.: 09/423,075

Examiner: S. Smith

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For: SHIELDING AN ELECTRONIC CARD WITH PRINTED CIRCUIT MOUNTED  
ON A METAL SUBSTRATE

Commissioner for Patents  
Washington, DC 20231

Sir:

This Amendment is submitted in response to the Office Action dated October 24, 2001,  
Applicants respectfully request consideration of the above-identified application in view of the  
following amendments and remarks.

**IN THE SPECIFICATION**

At page 1, at line 3 please insert:

B1

--FIELD OF THE INVENTION--.

At page 1, at line 10 please insert:

B2

--BACKGROUND OF THE INVENTION--.

At page 1, please delete the fifth full paragraph commencing at line 15 and insert  
therefor:

--According to a first type of solution, the electrical connection of the metal cover to

ground which the metal substrate constitutes is formed independently of the mechanical fixing of  
the cover with respect to the substrate and to the electronics card. For example, the electrical

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